

.050" X .050" MICRO STRIPS FTS SERIES

SPECIFICATIONS

For complete specifications and recommended PCB layouts see www.samtec.com?FTS

HI-TEMP

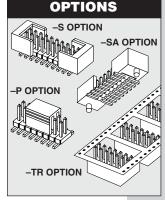
Insulator Material: Black Liquid Crystal Polymer Terminal Material: Phosphor Bronze Current Rating: 1.75A @ 80°C ambient Operating Temp Range: -55°C to +125°C Plating: Sn or Au over 50μ" (1,27µm) Ni RoHS Compliant:

Processing: Max Processing Temp:

230°C for 60 seconds, or 260°C for 20 seconds 3x with Matte Sn plating Lead-Free Solderable: Wave, or reflow with Matte Sn plating SMT Lead Coplanarity: .004" (0,10mm) max

Note: Some lengths, styles and options are non-standard non-returnable

Mates with: FFSD, CLP, FLE, SFMC(LIF)



Low profile Mates with (1,27mm) .050" socket strips or IDC cable Surface mount Shrouded and or through alignment pin hole options available (patent pending) **ALSO** Impedance **AVAILABLE** Micro pitch matched .050" x .050" for high speed Single row applications $(1,27mm \times 1,27mm)$ (Mates to CLP Series)

PER ROW

((- - - - -

LEAD **STYLE**

-01

= .120 (3,05) Post (Mates

with FFSD)

-02

= .075 (1,91) Post (Mates

with FLE)

-03

= .065 (1,65) Post (Mates

with CLP)

PLATING OPTION

on tail –F

— = 10μ" (0,25μm) Gold on post, Matte Tin

= Gold flash on post, **Matte Tin** on tail

ROW OPTION

Call Samtec.

-DV

= Double

Vertical SMT _D = Double **Row Through**

Hole

–SA

OTHER

OPTION

= Shrouded with Alignment Pin (05 thru 46 positions. Style -02 & -03 only. -SV not available.)

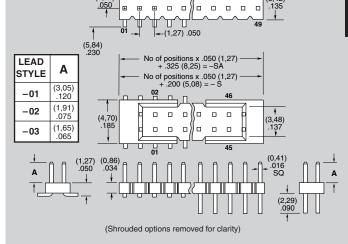
-S

= Shrouded (05 thru 46 positions. Style 02& -03 only. -SV not available.)

= Pick & Place (05 positions minimum) Pad (-SV & -S not available)

-TR

= Tape & Reel (-SV & -DV only)

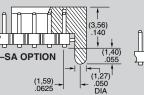


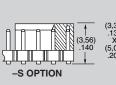
02 thru 50

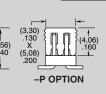
(except -S & -SA option = 05 thru 46)

No. of positions x .050 (1,27)

_ _ _







Due to technical progress, all designs, specifications and components are subject to change without notice.

WWW.SAMTEC.COM